

Vishay Siliconix

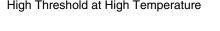
N-Channel 60-V (D-S) 175 °C MOSFET

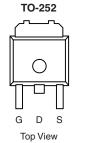
PRODUCT SUMMARY					
V _{DS} (V)	$r_{DS(on)}\left(\Omega\right)$	I _D (A) ^c	Q _g (Typ)		
60	0.0078 at V _{GS} = 10 V	93	94		

FEATURES

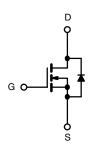
- TrenchFET® Power MOSFET
- 175 °C Junction Temperature
- 100 % R_q Tested
- High Threshold at High Temperature







Drain Connected to Tab



Ordering Information: SUD50N06-08H0-E3 (Lead (Pb)-free)

N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS $T_A = 3$	25 °C, unless othe	rwise noted			
Parameter	Symbol	Limit	Unit		
Drain-Source Voltage		V _{DS}	60	V	
Gate-Source Voltage		V _{GS}	± 20		
Continuous Drain Current /T 175 °C\b	T _C = 25 °C	I-	93°		
Continuous Drain Current (T _J = 175 °C) ^b	T _C = 125 °C	l _D	54 ^c		
Pulsed Drain Current		I _{DM}	100	A	
Continuous Source Current (Diode Conduction)		I _S	91 ^c		
Avalanche Current, Single Pulse	I _{AS}	I _{AS} 50			
Avalanche Energy	L = 0.1 mH	E _{AS}	125	mJ	
Maximum Power Dissipation	T _C = 25 °C	P _D	136 ^b	W	
Maximum Fower Dissipation	T _A = 25 °C	'b	3 ^a		
Operating Junction and Storage Temperature Range	T _J , T _{stg}	- 55 to 175	°C		

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Lunding to Australia	t ≤ 10 sec	R _{thJA}	15	18	°C/W
Junction-to-Ambient ^a	Steady State		40	50	
Junction-to-Case		R _{thJC}	0.85	1.1	

Notes:

- a. Surface Mounted on 1" x 1" FR4 Board.
- b. See SOA curve for voltage derating.
- c. Calculate continuous current based on maximum allowable junction temperature when using infinite heat sink. Package limitation current is 50 A.

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SPECIFICATIONS $T_J = 25^{\circ}$	C, unless of	otherwise noted					
Parameter	Symbol	Test Conditions	Min	Typ ^a	Max	Unit	
Static							
Drain-Source Breakdown Voltage	V _{(BR)DSS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	60			V	
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \mu A$	3.4		4.5	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}$			1	μА	
		$V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 125 ^{\circ}\text{C}$			50		
		$V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 175 ^{\circ}\text{C}$			250		
On-State Drain Current ^b	I _{D(on)}	$V_{DS} = 5 \text{ V}, V_{GS} = 10 \text{ V}$	50			Α	
		$V_{GS} = 10 \text{ V}, I_D = 20 \text{ A}$		0.0065	0.0078	Ω	
Drain-Source On-State Resistance ^b	r _{DS(on)}	V_{GS} = 10 V, I_D = 20 A, T_J = 125 °C			0.013		
		V_{GS} = 10 V, I_D = 20 A, T_J = 175 °C			0.0156		
Forward Transconductance ^b	9 _{fs}	$V_{DS} = 15 \text{ V}, I_{D} = 20 \text{ A}$		25		S	
Dynamic ^a							
Input Capacitance	C _{iss}			7000		pF	
Output Capacitance	C _{oss}	$V_{GS} = 0 \text{ V}, V_{DS} = 25 \text{ V}, F = 1 \text{ MHz}$		450			
Reverse Transfer Capacitance	C _{rss}			240			
Gate Resistance	R_g	f = 1 MHz	0.75	1.5	2.3	Ω	
Total Gate Charge ^c	Q_g			94	145		
Gate-Source Charge ^c	Q _{gs}	$V_{DS} = 30 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 50 \text{ A}$		35		nC	
Gate-Drain Charge ^c	Q_{gd}			20			
Turn-On Delay Time ^c	t _{d(on)}			28	45		
Rise Time ^c	t _r	V_{DD} = 30 V, R_L = 0.6 Ω		13	20	ns	
Turn-Off Delay Time ^c	t _{d(off)}	$I_D\cong 50$ A, V_{GEN} = 10 V, R_g = 2.5 Ω		50	75		
Fall Time ^c	t _f			10	15		
Source-Drain Diode Ratings and Cha	racteristics	(T _C = 25 °C)			<u> </u>		
Pulsed Current	I _{SM}				100	Α	
Diode Forward Voltage ^b	V _{SD}	I _F = 50 A, V _{GS} = 0 V		1.0	1.5	V	
Source-Drain Reverse Recovery Time	t _{rr}	$I_F = 50 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s}$		45	70	ns	

Notes:

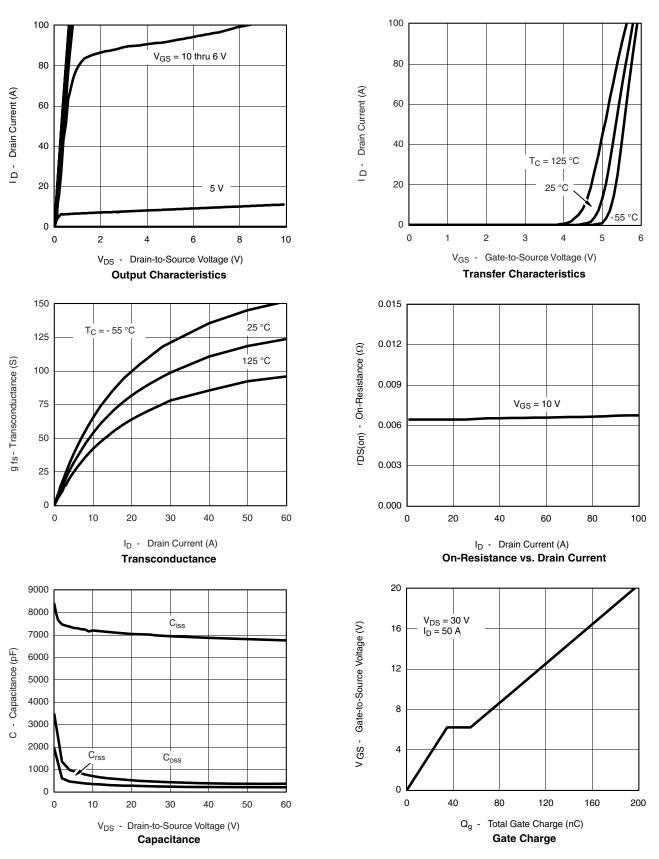
- a. Guaranteed by design, not subject to production testing.
- b. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



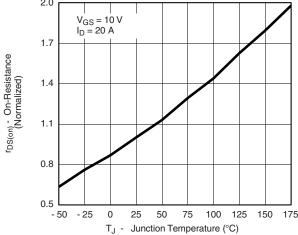
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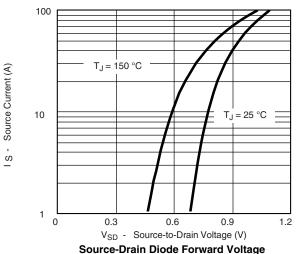
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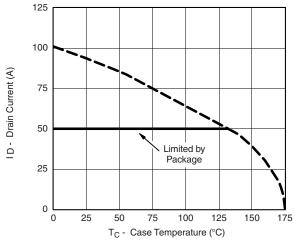
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



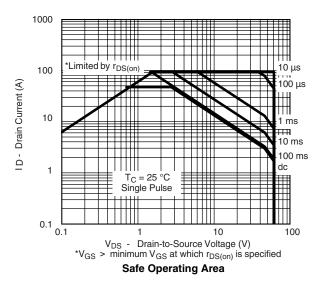
On-Resistance vs. Junction Temperature

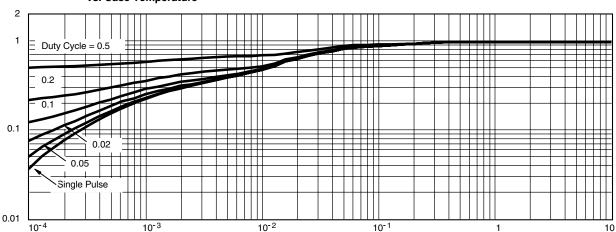


THERMAL RATINGS



Maximum Avalanche Drain Current vs. Case Temperature





Square Wave Pulse Duration (sec) Normalized Thermal Transient Impedance, Junction-to-Case

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Normalized Effective Transient Thermal Impedance



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